

Abstract

5 A socket assembly for accommodating an IC chip or package
(IC) provided with a socket body having a generally
10 rectangular configuration. A plurality of flat plate-like
contact pins are arranged forming rows in parallel with each
other so as to form rows along four sides of the socket body,
respectively. Each contact pin has a base portion and an arm
which extends curved upward from the base portion. An upward
15 contact portion for coming into contact with a terminal of an
IC is formed on one end of the base portion of the contact
pin, and a connecting portion for the connection to the
printed circuit board is formed on the other end of the base
portion. Four sliders are arranged along the four sides of the
20 socket body, respectively. Each slider is supported by the
base portions and arms of the row-forming contact pins and can
move between an open position for accommodating the IC and a
pressing position for pressing against the IC by an elastic
force of the arms to bring the terminals of the IC into press-
contact with the contact portions of the contact pins.

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